

# 16-Channel Constant Current LED Sink Driver with Low Knee Voltage

### **Features**

- 16 constant-current output channels
- Constant output current invariant to load voltage change:
   Constant output current range:
  - 3-40mA@V<sub>DD</sub>=5V;
  - 3-30mA@V<sub>DD</sub>=3.3V
- · Excellent output current accuracy:
  - -between channels: ±3% (typ.) and ±5% (max.)
  - -between ICs: ±3% (typ.) and ±6% (max.)
- Low Knee Voltage:

 $I_{OUT}$ =20mA@ $V_{DS}$ =0.2V;  $V_{DD}$ =3.3V

 $I_{OUT}$ =20mA@ $V_{DS}$ =0.2V;  $V_{DD}$ =5.0V

- Output current adjusted through an external resistor
- Fast response of output current, OE (min.): 70ns with good uniformity between output channels
- Staggered delay of output
- 25MHz clock frequency
- Schmitt trigger input
- 3.3V/ 5V supply voltage
- "Pb-free & Green" Package

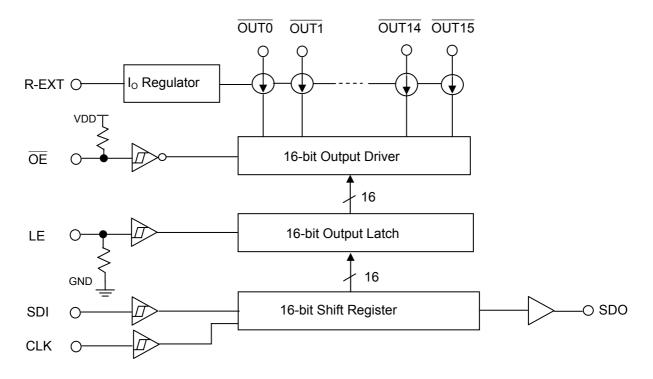
# Small Outline Package GF: SOP24-300-1.00 Shrink SOP GP: SSOP24L-150-0.64

### **Product Description**

MBI5035 is a 16-channel constant current LED driver with  $V_{DS}$ =0.2V @  $I_{OUT}$ =20mA, which is excellent compared to the conventional design. MBI5035 is especially designed for low power consumption LED display applications. The low knee voltage (LKV) design makes MBI5035 work at a constant output current with low  $V_{DS}$  and still guarantees PrecisionDrive  $^{TM}$  feature. With PrecisionDrive  $^{TM}$ , MBI5035 is designed for LED displays which require to operate at low current and match the luminous intensity of each channel. MBI5035 contains a serial buffer and data latches which convert serial input data into parallel output format. At MBI5035 output stage, sixteen regulated current ports are designed to provide uniform and constant current sinks for driving LEDs within a large range of  $V_F$  variations.

MBI5035 provides users with great flexibility and device performance in their low power system design for LED display applications. It accepts an input voltage range from 3.3V to 5.0V and maintains constant current up from 3mA to 40mA determined by an external resistor,  $R_{\text{ext}}$ , which gives users flexibility in controlling the light intensity of LEDs. MBI5035 guarantees to endure maximum 17V at the output port. The high clock frequency, 25 MHz, also satisfies the system requirements of high volume data transmission.

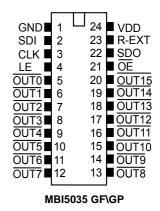
### **Block Diagram**



### **Terminal Description**

| Pin No. | Pin Name     | Function   |
|---------|--------------|--|
| 1       | GND          | Ground terminal for control logic and current sink   |
| 2       | SDI          | Serial-data input to the shift register  |
| 3       | CLK          | Clock input terminal for data shift on rising edge   |
| 4       | LE           | Data strobe input terminal Serial data is transferred to the output latch when LE is high. The data will be latched when LE goes low.                                    |
| 5~20    | OUT0 ∼ OUT15 | Constant current output terminals  |
| 21      | ŌĒ           | Output enable terminal  When $\overline{OE}$ is (active) low, the output drivers are enabled; when $\overline{OE}$ is high, all output drivers are turned OFF (blanked). |
| 22      | SDO          | Serial-data output to the following SDI of next driver IC. SDO signal changes on rising edge of CLK.   |
| 23      | R-EXT        | Input terminal used to connect an external resistor for setting up output current for all output channels  |
| 24      | VDD          | 3.3V/5V supply voltage terminal  |

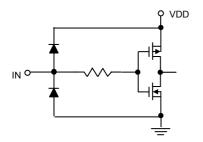
### **Pin Configuration**



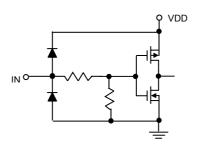
### **Equivalent Circuits of Inputs and Outputs**

OE terminal

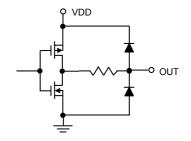
**CLK**, SDI terminal



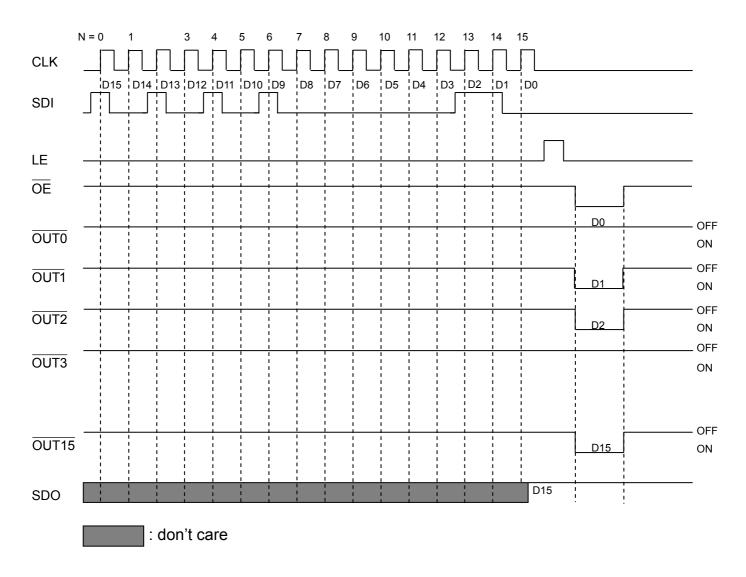
LE terminal



**SDO terminal** 



### **Timing Diagram**



### **Truth Table**

| CLK      | LE | ŌĒ | SDI              | OUTO OUT 7<br>OUT15   | SDO               |
|----------|----|----|------------------|---|-------------------|
|          | Н  | L  | D <sub>n</sub>   | Dn Dn - 7 Dn - 15   | D <sub>n-15</sub> |
|          | L  | L  | D <sub>n+1</sub> | No Change   | D <sub>n-14</sub> |
|          | Н  | L  | D <sub>n+2</sub> | $\overline{D_{n+2}} \dots \overline{D_{n-5}} \dots \overline{D_{n-13}}$ | D <sub>n-13</sub> |
| <b>—</b> | X  | L  | D <sub>n+3</sub> | Dn+2Dn-5Dn-13   | D <sub>n-13</sub> |
| $\Box$   | X  | Н  | D <sub>n+4</sub> | Off   | D <sub>n-13</sub> |

### **Maximum Ratings**

| Characteristic           |         | Symbol           | Rating                    | Unit |
|--------------------------|---------|------------------|---------------------------|------|
| Supply Voltage           |         | V <sub>DD</sub>  | 0~7.0                     | V    |
| Input Voltage            |         | V <sub>IN</sub>  | -0.4~V <sub>DD</sub> +0.4 | V    |
| Output Current           |         | l <sub>оит</sub> | +50                       | mA   |
| Sustaining Voltage at OU | JT Port | V <sub>DS</sub>  | -0.5~+17.0                | V    |
| GND Terminal Current     |         | I <sub>GND</sub> | +800                      | mA   |
| Power Dissipation        | GF-type | Б                | 2.35                      | 10/  |
| (On PCB, Ta=25°C)        | GP-type | P <sub>D</sub>   | 1.76                      | W    |
| Thermal Resistance       | GF-type | В                | 53.28                     | °C/W |
| (On PCB, Ta=25°C)        | GP-type | $R_{th(j-a)}$    | 70.90                     | C/VV |
| Junction Temperature     |         | $T_{j,max}$      | 150**                     | °C   |
| Operating Temperature    |         | T <sub>opr</sub> | -40~+85                   | °C   |
| Storage Temperature      |         | T <sub>stg</sub> | -55~+150                  | °C   |

<sup>\*</sup>The PCB size is 76.2mm\*114.3mm in simulation. Please refer to JEDEC JESD51.

Note: The performance of thermal dissipation is strongly related to the size of thermal pad, thickness and layer numbers of the PCB. The empirical thermal resistance may be different from simulative value. User should plan for expected thermal dissipation performance by selecting package and arranging layout of the PCB to maximize the capability.

<sup>\*\*</sup> Operation at the maximum rating for extended periods may reduce the device reliability; therefore, the suggested operation temperature of the device is under 125°C.

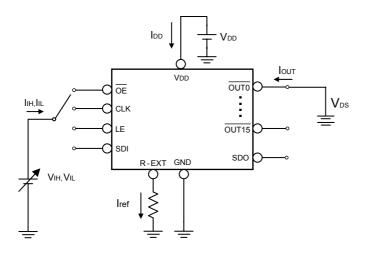
### Electrical Characteristics ( $V_{DD}$ = 5.0V)

| Characte                         | eristics   | Symbol                  | Cond   | dition                  | Min.                | Тур. | Max.                | Unit |
|----------------------------------|------------|-------------------------|--|-------------------------|---------------------|------|---------------------|------|
| Supply Voltage                   | ;          | $V_{DD}$                |  | -                       | 4.5                 | 5.0  | 5.5                 | V    |
| Sustaining Vol                   | age at OUT | $V_{DS}$                | OUT0 ~ OUT15   |                         | -                   | -    | 17.0                | V    |
|                                  |            | I <sub>OUT</sub>        | Refer to "Test Cir<br>Characteristics"   | rcuit for Electrical    | 3                   | -    | 40                  | mA   |
| Output Current                   |            | I <sub>OH</sub>         | SDO  |                         | -                   | -    | -1.0                | mA   |
|                                  |            | I <sub>OL</sub>         | SDO  |                         | -                   | -    | 1.0                 | mA   |
| Input Voltage                    | "H" level  | $V_{IH}$                | Ta =-40~85°C   |                         | 0.7*V <sub>DD</sub> | ı    | $V_{DD}$            | V    |
| iliput voltage                   | "L" level  | $V_{IL}$                | Ta =-40~85°C   |                         | GND                 | 1    | 0.3*V <sub>DD</sub> | V    |
| Output Leakag                    | e Current  | I <sub>OH</sub>         | V <sub>DS</sub> =17.0V   |                         | -                   | 1    | 0.5                 | μΑ   |
| Output Voltage                   | SDO        | $V_{OL}$                | I <sub>OL</sub> =+1.0mA  |                         | -                   | ı    | 0.4                 | V    |
| Output Voltage                   | 300        | $V_{OH}$                | I <sub>OH</sub> =-1.0mA  |                         | 4.6                 | -    | -                   | V    |
| Output Current                   | 1          | I <sub>OUT1</sub>       | V <sub>DS</sub> =0.25V   | R <sub>ext</sub> =930 Ω | -                   | 20   | -                   | mA   |
| Current Skew (                   | Channel)   | dl <sub>OUT1</sub>      | $I_{OUT}$ =20mA<br>$V_{DS}$ =0.25V $R_{ext}$ =930 $\Omega$   |                         | -                   | ±3.0 | ±5.0                | %    |
| Current Skew (                   | IC)        | dl <sub>OUT2</sub>      | $I_{OUT}$ =20mA<br>$V_{DS}$ =0.25V   | R <sub>ext</sub> =930Ω  | -                   | ±3.0 | ±6.0                | %    |
| Output Current<br>Output Voltage | Regulation | $\%/dV_{DS}$            | V <sub>DS</sub> within 0.5V a  | ind 1.5V                | -                   | ±0.2 | ±0.5                | %/V  |
| Output Current<br>Supply Voltage |            | $\%/dV_{DD}$            | V <sub>DD</sub> within 4.5V a  | and 5.5V                | -                   | ±1.0 | ±2.0                | %/V  |
| Low Knee Volt                    | age        | $V_{DS}$                | I <sub>OUT</sub> =20mA   |                         | -                   | 0.2  | 0.25                | V    |
| Pull-up Resisto                  | or         | R <sub>IN</sub> (up)    | ŌĒ   |                         | 250                 | 500  | 800                 | ΚΩ   |
| Pull-down Res                    | stor       | R <sub>IN</sub> (down)  | LE   |                         | 250                 | 500  | 800                 | ΚΩ   |
|                                  |            | I <sub>DD</sub> (off) 1 | R <sub>ext</sub> =Open, <del>OUT</del> 0 ~ <del>OUT</del> 15 =Off                                  |                         | -                   | 2.5  | 4.5                 |      |
|                                  | "OFF"      | I <sub>DD</sub> (off) 2 | $R_{\text{ext}} = 6000\Omega$ , $\overline{\text{OUT0}} \sim \overline{\text{OUT15}} = \text{Off}$ |                         | -                   | 3.5  | 5.5                 |      |
| Supply<br>Current                |            | I <sub>DD</sub> (off) 3 | R <sub>ext</sub> =930Ω,  | T0 ~ OUT15 =Off         | -                   | 7.0  | 9.0                 | mA   |
|                                  | "ON"       | I <sub>DD</sub> (on) 1  | R <sub>ext</sub> =6000Ω, <del>OU</del>   | T0~OUT15 =On            | -                   | 3.5  | 5.5                 |      |
|                                  | ON         | I <sub>DD</sub> (on) 2  | R <sub>ext</sub> =930Ω,  | T0~OUT15 =On            | -                   | 7.0  | 9.5                 |      |

# Electrical Characteristics ( $V_{DD}$ = 3.3V)

| Characte                         | eristics  | Symbol                  | Cone   | dition                 | Min.                | Тур. | Max.                | Unit |
|----------------------------------|---|-------------------------|--|------------------------|---------------------|------|---------------------|------|
| Supply Voltage                   |   | $V_{DD}$                |  | -                      | 3.0                 | 3.3  | 3.6                 | V    |
| Sustaining Volt<br>Ports         | age at OUT  | V <sub>DS</sub>         | OUT0 ~ OUT15   | -                      | -                   | -    | 17.0                | V    |
|                                  |   | I <sub>OUT</sub>        | Refer to "Test Ci<br>Characteristics"  | rcuit for Electrical   | 3                   | -    | 30                  | mA   |
| Output Current                   |   | I <sub>OH</sub>         | SDO  |                        | -                   | -    | -1.0                | mA   |
|                                  |   | I <sub>OL</sub>         | SDO  |                        | -                   | -    | 1.0                 | mA   |
| land to Valtage                  | "H" level   | V <sub>IH</sub>         | Ta=-40~85°C  |                        | 0.7*V <sub>DD</sub> | -    | $V_{DD}$            | V    |
| Input Voltage                    | "L" level   | V <sub>IL</sub>         | Ta=-40~85°C  |                        | GND                 | -    | 0.3*V <sub>DD</sub> | V    |
| Output Leakag                    | e Current   | I <sub>OH</sub>         | V <sub>DS</sub> =17.0V   |                        | -                   | -    | 0.5                 | μA   |
| Ott \ /alta                      | 000   | V <sub>OL</sub>         | I <sub>OL</sub> =+1.0mA  |                        | -                   | -    | 0.4                 | V    |
| Output Voltage                   | SDO   | V <sub>OH</sub>         | I <sub>OH</sub> =-1.0mA  |                        | 2.9                 | -    | -                   | V    |
| Output Current                   | 1   | I <sub>OUT1</sub>       | V <sub>DS</sub> =0.25V R <sub>ext</sub> =930 Ω   |                        | -                   | 20   | -                   | mA   |
| Current Skew (                   | Channel)  | dl <sub>OUT1</sub>      | $I_{OUT}$ =20mA<br>$V_{DS}$ =0.25V $R_{ext}$ =930 $\Omega$                                   |                        | -                   | ±3.0 | ±5.0                | %    |
| Current Skew (                   | IC)   | dl <sub>OUT2</sub>      | I <sub>OUT</sub> =20mA<br>V <sub>DS</sub> =0.25V   | R <sub>ext</sub> =930Ω | -                   | ±3.0 | ±6.0                | %    |
| Output Current<br>Output Voltage | Regulation  | $\%/dV_{DS}$            | V <sub>DS</sub> within 0.5V a  | and 1.5V               | -                   | ±0.2 | ±0.5                | %/V  |
| Output Current<br>Supply Voltage |   | %/dV <sub>DD</sub>      | V <sub>DD</sub> within 3.0V a  | and 3.6V               | -                   | ±1.0 | ±2.0                | %/V  |
| Low Knee Volta                   | age   | $V_{DS}$                | I <sub>OUT</sub> =20mA   |                        | -                   | 0.2  | 0.25                | V    |
| Pull-up Resisto                  | r   | R <sub>IN</sub> (up)    | ŌĒ   |                        | 250                 | 500  | 800                 | ΚΩ   |
| Pull-down Res                    | stor  | R <sub>IN</sub> (down)  | LE   |                        | 250                 | 500  | 800                 | ΚΩ   |
|                                  | I <sub>DD</sub> (off) 1 R <sub>ext</sub> =Open, OUT0 ~ OUT15 =Off |                         | -  | 2.0                    | 4.0                 |      |                     |      |
|                                  | "OFF"   | I <sub>DD</sub> (off) 2 | $R_{\text{ext}}$ =6000 $\Omega$ , $\overline{\text{OUT0}} \sim \overline{\text{OUT15}}$ =Off |                        | -                   | 3.0  | 5.0                 |      |
| Supply<br>Current                |   | I <sub>DD</sub> (off) 3 |  | T0 ~ OUT15 =Off        | -                   | 6.5  | 8.5                 | mA   |
|                                  | "ON!"   | I <sub>DD</sub> (on) 1  |  |                        | -                   | 3.0  | 5.5                 |      |
|                                  | "ON"  | I <sub>DD</sub> (on) 2  |  | T0 ~ OUT15 =On         | -                   | 6.5  | 9.0                 |      |

### **Test Circuit for Electrical Characteristics**



### **Switching Characteristics (V<sub>DD</sub>= 5.0V)**

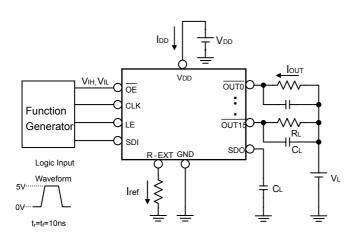
| Characteristics                  |                                   | Symbol              | Condition   | Min. | Тур. | Max. | Unit |
|----------------------------------|-----------------------------------|---------------------|---|------|------|------|------|
|                                  | CLK-OUT0                          | t <sub>pLH1</sub>   |   | -    | 55   | 65   | ns   |
| Propagation Delay Time           | LE-OUT0                           | t <sub>pLH2</sub>   |   | -    | 55   | 65   | ns   |
| ("L" to "H")                     | OE - OUTO                         | t <sub>pLH3</sub>   |   | -    | 55   | 65   | ns   |
|                                  | CLK-SDO                           | t <sub>pLH</sub>    |   | -    |      | 40   | ns   |
|                                  | CLK-OUT0                          | t <sub>pHL1</sub>   |   | 1    | 35   | 45   | ns   |
| Propagation Delay Time           | LE-OUTO                           | t <sub>pHL2</sub>   |   | -    | 35   | 45   | ns   |
| ("H" to "L")                     | OE - OUTO                         | t <sub>pHL3</sub>   |   | -    | 35   | 45   | ns   |
|                                  | CLK-SDO                           | t <sub>pHL</sub>    |   | -    |      | 40   | ns   |
| Staggered Delay of<br>Output*    | Output Group 1~<br>Output Group 2 | t <sub>stag1</sub>  | V <sub>IH</sub> =V <sub>DD</sub><br>V <sub>II</sub> =GND            | -    | 5    | 10   | ns   |
| Dulas Midth                      | CLK                               | t <sub>w(CLK)</sub> | Rext=930Ω   | 20   | -    | -    | ns   |
| Pulse Width                      | LE                                | t <sub>w(L)</sub>   | $R_L=150\Omega$<br>$C_L=10PF$                                       | 20   | -    | -    | ns   |
| Data Clock Frequency             |                                   | F <sub>CLK</sub>    | I <sub>OUT</sub> =20mA  | 1    | -    | 25   | MHz  |
| Hold Time for LE                 |                                   | t <sub>h(L)</sub>   | C1=100nF<br>C2=22 µ F   | 10   | -    | -    | ns   |
| Setup Time for LE                |                                   | t <sub>su(L)</sub>  | C <sub>SDO</sub> =10PF  | 10   | -    | -    | ns   |
| Hold Time for SDI                |                                   | t <sub>h(D)</sub>   | V <sub>L</sub> =3.3V  | 5    | -    | -    | ns   |
| Setup Time for SDI               |                                   | t <sub>su(D)</sub>  |   | 3    | -    | -    | ns   |
| Maximum CLK Rise Time            | )                                 | t <sub>r</sub>      |   | -    | -    | 500  | ns   |
| Maximum CLK Fall Time            |                                   | t <sub>f</sub>      |   | -    | -    | 500  | ns   |
| SDO Rise Time                    |                                   | $t_{r,SDO}$         |   | -    | 10   | _    | ns   |
| SDO Fall Time                    |                                   | $t_{f,SDO}$         |   | -    | 10   | -    | ns   |
| Output Rise Time of Output Ports |                                   | t <sub>or</sub>     |   | 30   | 35   |      | ns   |
| Output Fall Time of Output Ports |                                   | t <sub>of</sub>     |   | 30   | 35   | -    | ns   |
| OE Pulse Width                   |                                   | t <sub>w(OE)</sub>  |   | 70   | 100  | -    | ns   |
| Output On-time Error             |                                   | t <sub>ON_ERR</sub> | On/off latch data=all "1", 70 ns OE low level one -shot pulse input | 0    | 7    | 12   | ns   |

<sup>\*</sup> MBI5035 has a built-in stagger circuit to perform delay mechanism. Among output ports exist a graduated 5ns delay time between  $\overline{OUT2n}$  and  $\overline{OUT2n+1}$ , by which the output ports will be divided to two groups at a different time so that the instant current from the power line will be lowered.

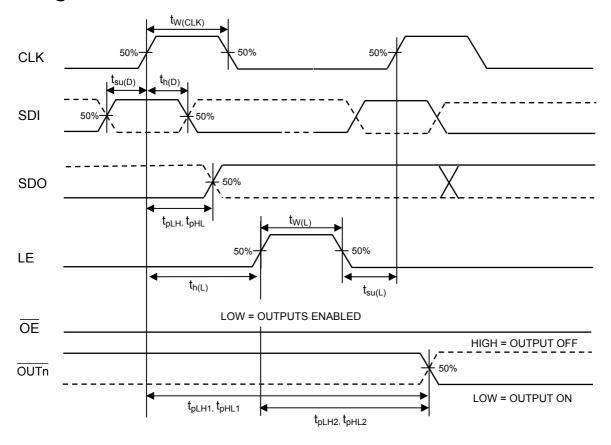
**Switching Characteristics (V<sub>DD</sub>= 3.3V)** 

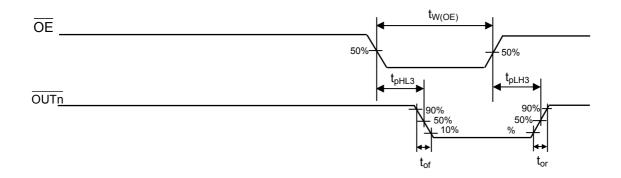
| Switching onai                      |                                   | <u> </u>            |   |      |      |      |      |
|-------------------------------------|-----------------------------------|---------------------|---|------|------|------|------|
| Character                           | istics                            | Symbol              | Condition   | Min. | Тур. | Max. | Unit |
|                                     | CLK-OUT0                          | t <sub>pLH1</sub>   |   | -    | 65   | 75   | ns   |
| Propagation Delay Time              | LE-OUT0                           | t <sub>pLH2</sub>   |   |      | 65   | 75   | ns   |
| Propagation Delay Time ("L" to "H") | OE - OUTO                         | t <sub>pLH3</sub>   |   | -    | 65   | 75   | ns   |
|                                     | CLK-SDO                           | t <sub>pLH</sub>    |   | -    | -    | 50   | ns   |
|                                     | CLK-OUT0                          | t <sub>pHL1</sub>   |   | -    | 40   | 50   | ns   |
| Propagation Delay Time              | LE-OUT0                           | t <sub>pHL2</sub>   |   | -    | 40   | 50   | ns   |
| ("H" to "L")                        | OE - OUTO                         | t <sub>pHL3</sub>   |   | -    | 40   | 50   | ns   |
|                                     | CLK-SDO                           | t <sub>pHL</sub>    |   | -    | -    | 50   | ns   |
| Staggered Delay of<br>Output        | Output Group 1~<br>Output Group 2 | t <sub>stag1</sub>  | V <sub>IH</sub> =V <sub>DD</sub><br>V <sub>IL</sub> =GND            | -    | 7    | 15   | ns   |
| Dulgo Width                         | CLK                               | t <sub>w(CLK)</sub> | Rext=930Ω   | 20   | -    | -    | ns   |
| Pulse Width                         | LE                                | $t_{w(L)}$          | $R_L=150\Omega$<br>$C_L=10PF$                                       | 20   | -    | -    | ns   |
| Data Clock Frequency                |                                   | F <sub>CLK</sub>    | I <sub>OUT</sub> =20mA  | -    | -    | 20   | MHz  |
| Hold Time for LE                    |                                   | t <sub>h(L)</sub>   | C1=100nF<br>C2=22 µ F   | 10   | -    | -    | ns   |
| Setup Time for LE                   |                                   | t <sub>su(L)</sub>  | C <sub>SDO</sub> =10PF  | 10   | -    | -    | ns   |
| Hold Time for SDI                   |                                   | t <sub>h(D)</sub>   | V <sub>L</sub> =3.3V  | 5    | -    | -    | ns   |
| Setup Time for SDI                  |                                   | t <sub>su(D)</sub>  |   | 3    | -    | -    | ns   |
| Maximum CLK Rise Time               | •                                 | t <sub>r</sub>      |   | -    | -    | 500  | ns   |
| Maximum CLK Fall Time               |                                   | t <sub>f</sub>      |   | ı    | -    | 500  | ns   |
| SDO Rise Time                       |                                   | $t_{r,SDO}$         |   | ı    | 10   | -    | ns   |
| SDO Fall Time                       |                                   | $t_{f,SDO}$         |   | ı    | 10   | -    | ns   |
| Output Rise Time of Output Ports    |                                   | t <sub>or</sub>     |   | 35   | 40   |      | ns   |
| Output Fall Time of Output Ports    |                                   | t <sub>of</sub>     |   | 35   | 40   | -    | ns   |
| OE Pulse Width                      |                                   | $t_{w(OE)}$         |   | 100  | 130  | -    | ns   |
| Output On-time Error                |                                   | t <sub>ON_ERR</sub> | On/off latch data=all "1", 70 ns OE low level one -shot pulse input | 0    | 10   | 16   | ns   |

# **Test Circuit for Switching Characteristics**



### **Timing Waveform**



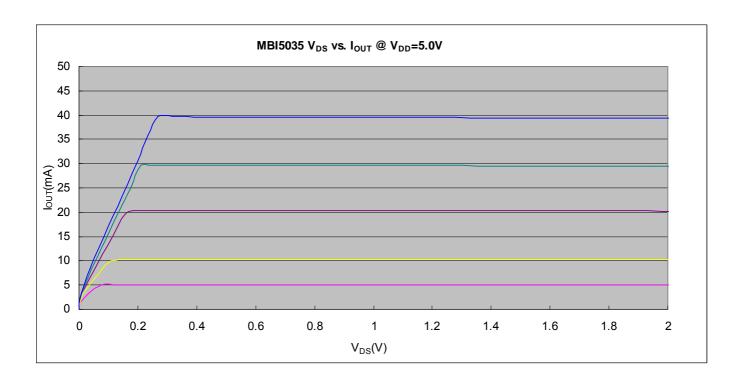


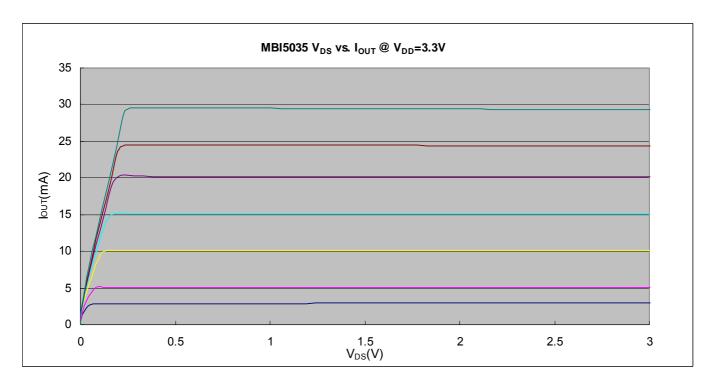
### **Application Information**

### **Constant Current**

To design LED displays, MBI5035 provides nearly no variations in current from channel to channel and from IC to IC. This can be achieved by:

- 1) The maximum current variation between channels is less than ±3%, and that between ICs is less than ±6%.
- 2) In addition, the current characteristic of output stage is flat and users can refer to the below figure. The output current can be kept constant regardless of the variations of LED forward voltages(V<sub>F</sub>). This performs as a perfect static load regulation.





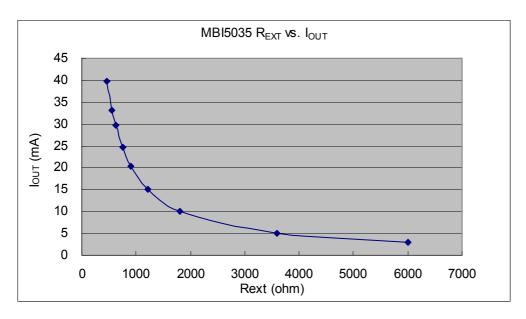
### **Adjusting Output Current**

### with Low Knee Voltage

The output current of each channel ( $I_{OUT}$ ) is set by an external resistor,  $R_{ext}$ . The relationship between  $I_{OUT}$  and  $R_{ext}$  is shown in the following figure.

Also, the output current can be calculated from the equation:

 $V_{R-EXT}$ =1.24V;  $I_{OUT}$ = $V_{R-EXT}$ \*(1/Rext)x15;  $R_{ext}$ =( $V_{R-EXT}$ / $I_{OUT}$ )x15



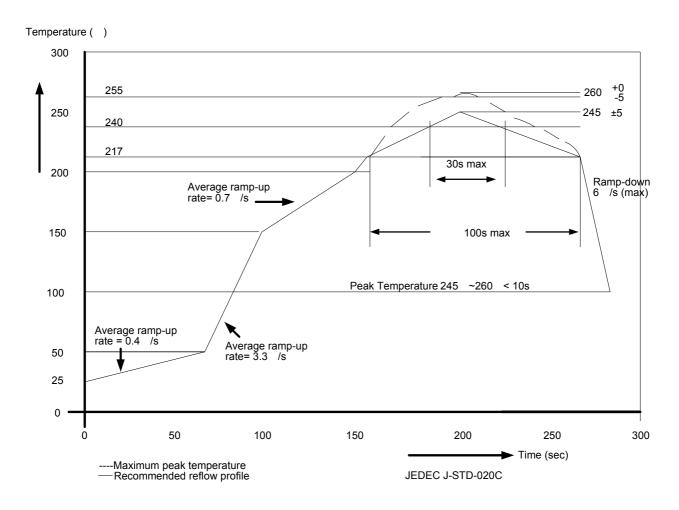
Where  $R_{ext}$  is the resistance of the external resistor connected to R-EXT terminal and  $V_{R-EXT}$  is the voltage of R-EXT terminal. The magnitude of current (as a function of  $R_{ext}$ ) is around 20mA at 930 $\Omega$  and 10mA at 1860 $\Omega$ .

### **Staggered Delay of Output**

MBI5035 has a built-in staggered circuit to perform delay mechanism. Among output ports exist a graduated 5ns delay time between  $\overline{OUT2n}$  and  $\overline{OUT2n+1}$ , by which the output ports will be divided to two groups at a different time so that the instant current from the power line will be lowered.

# with Low Knee Voltage Soldering Process of "Pb-free" Package Plating\*

Macroblock has defined "Pb-Free" to mean semiconductor products that are compatible with the current RoHS requirements and selected 100% pure tin (Sn) to provide forward and backward compatibility with the higher-temperature Pb-free processes. Pure tin is widely accepted by customers and suppliers of electronic devices in Europe, Asia and the US as the lead-free surface finish of choice to replace tin-lead. Also, it adopts tin/lead (SnPb) solder paste, and please refer to the JEDEC J-STD-020C for the temperature of solder bath. However, in the whole Pb-free soldering processes and materials, 100% pure tin (Sn) will all require from 245 °C to 260°C for proper soldering on boards, referring to JEDEC J-STD-020C as shown below.



| Package Thickness | Volume mm <sup>3</sup><br><350 | Volume mm <sup>3</sup><br>350-2000 | Volume mm <sup>3</sup><br>2000 |
|-------------------|--------------------------------|------------------------------------|--------------------------------|
| <1.6mm            | 260 +0 °C                      | 260 +0 °C                          | 260 +0 °C                      |
| 1.6mm – 2.5mm     | 260 +0 °C                      | 250 +0 °C                          | 245 +0 °C                      |
| 2.5mm             | 250 +0 °C                      | 245 +0 °C                          | 245 +0 °C                      |

<sup>\*</sup>Note: For details, please refer to Macroblock's "Policy on Pb-free & Green Package".

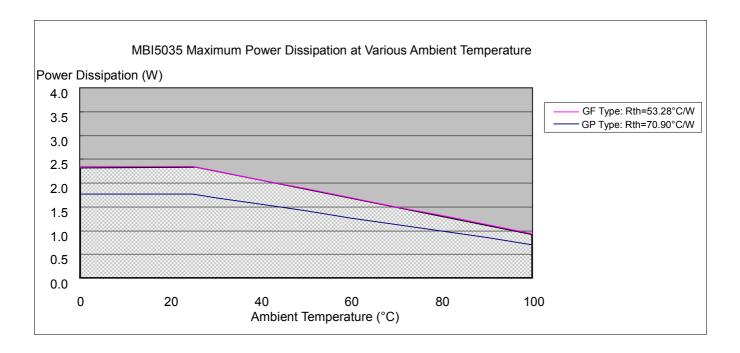
### **Package Power Dissipation (PD)**

### with Low Knee Voltage

The maximum allowable package power dissipation is determined as  $P_D(max)=(Tj-Ta)/R_{th(j-a)}$ . When 16 output channels are turned on simultaneously, the actual package power dissipation is

 $P_D(act)=(I_{DD}xV_{DD})+(I_{OUT}xDutyxV_{DS}x16)$ . Therefore, to keep  $P_D(act)\leq P_D(max)$ , the allowable maximum output current as a function of duty cycle is:

 $I_{OUT} = \{ [(Tj-Ta)/R_{th(j-a)}] - (I_{DD}xV_{DD})\}/V_{DS}/Duty/16, where Tj=150°C.$ 



| Condition: I <sub>OUT</sub> =50mA, 16 output channels |                      |  |  |  |
|---|----------------------|--|--|--|
| Device Type   | $R_{th(j-a)}$ (°C/W) |  |  |  |
| GF  | 53.28                |  |  |  |
| GP  | 70.90                |  |  |  |

The maximum power dissipation,  $P_D(max)=(Tj-Ta)/R_{th(j-a)}$ , decreases as the ambient temperature increases.

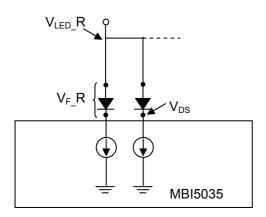
### Load Supply Voltage (V<sub>LED</sub>)

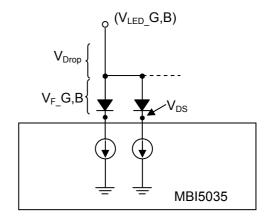
### with Low Knee Voltage

MBI5035 are designed to operate with  $V_{DS}$  ranging from 0.2V to 0.6V (depending on  $I_{OUT}$ =3~40mA) to lower the heat dissipation and reduce the temperature on the package. In this case, it is recommended to use the lowest possible supply voltage  $V_{LED}$ . Because the  $V_F$  of red LED differs from green and blue LED, we suggest to separate  $V_{LED}$  from  $V_{LED}$ .

 $V_{DS}$ = $V_{LED}$ - $V_F$  , with  $V_{DS}$  ranging from 0.2V to 0.6V

The applications are shown in the following figures.

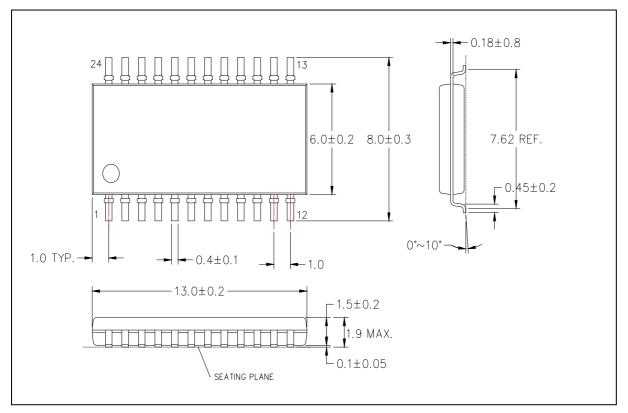




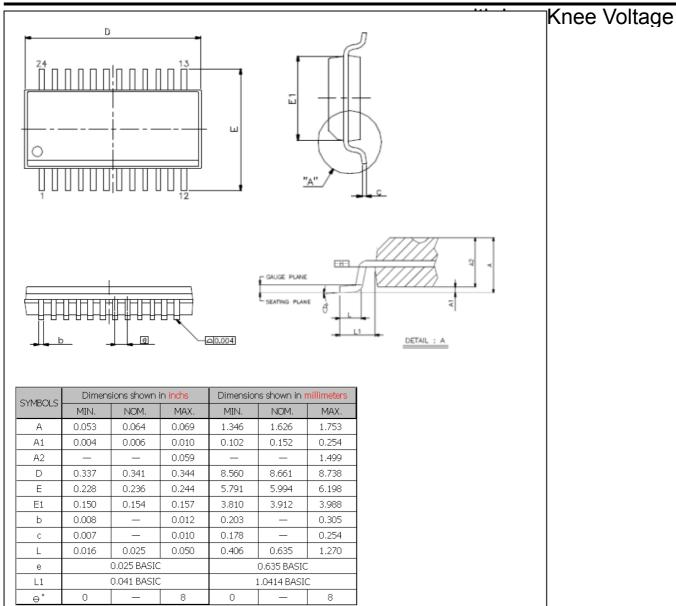
### **Switching Noise Reduction**

LED driver ICs are frequently used in switch-mode applications which always behave with switching noise due to the parasitic inductance on PCB. To eliminate switching noise, refer to "Application Note for 8-bit and 16-bit LED Drivers- Overshoot".

### **Package Outline**



MBI5035GF Outline Drawing

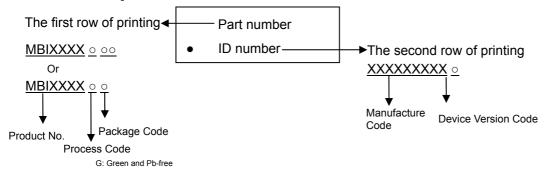


MBI5035 GP Outline Drawing

Note: The unit for the outline drawing is mm.

### **Product Top-mark Information**

## with Low Knee Voltage



### **Product Revision History**

| Datasheet version | Device version code |  |  |
|-------------------|---------------------|--|--|
| V1.00             | Α                   |  |  |
| V1.01             | Α                   |  |  |

### **Product Ordering Information**

| Part Number | "Pb-free & Green"<br>Package Type | Weight (g) |
|-------------|-----------------------------------|------------|
| MBI5035GF   | SOP24L-300-1.00                   | 0.28       |
| MBI5035GP   | SSOP24L-150-0.64                  | 0.11       |

### **Disclaimer**

Macroblock reserves the right to make changes, corrections, modifications, and improvements to their products and documents or discontinue any product or service without notice. Customers are advised to consult their sales representative for the latest product information before ordering. All products are sold subject to the terms and conditions supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

Macroblock's products are not designed to be used as components in device intended to support or sustain life or in military applications. Use of Macroblock's products in components intended for surgical implant into the body, or other applications in which failure of Macroblock's products could create a situation where personal death or injury may occur, is not authorized without the express written approval of the Managing Director of Macroblock. Macroblock will not be held liable for any damages or claims resulting from the use of its products in medical and military applications.

All text, images, logos and information contained on this document is the intellectual property of Macroblock.

Unauthorized reproduction, duplication, extraction, use or disclosure of the above mentioned intellectual property will be deemed as infringement.